

ON Semiconductor[®]

ISL9R1560G2, ISL9R1560P2, ISL9R1560S2, ISL9R1560S3S 15 A, 600 V, STEALTH[™] Diode

Features

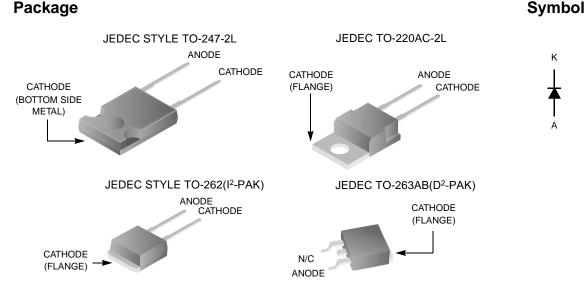
- Stealth Recovery t_{rr} = 29.4 ns (@ I_F = 15 A)
- Max Forward Voltage, V_F = 2.2 V (@ T_C = 25°C)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- SMPS
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode

Description

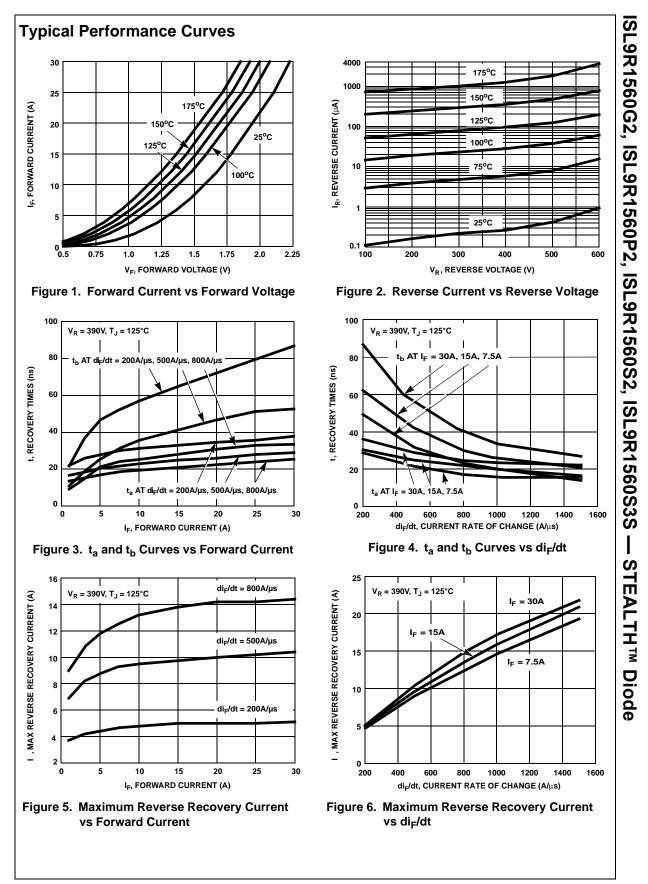
The ISL9R1560G2, ISL9R1560P2, ISL9R1560S2, ISL9R1560S3S is a STEALTH[™] diode optimized for low loss performance in high frequency hard switched applications. The STEALTH[™] family exhibits low reverse recovery current (I_{rr}) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{rr} and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH[™] diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.



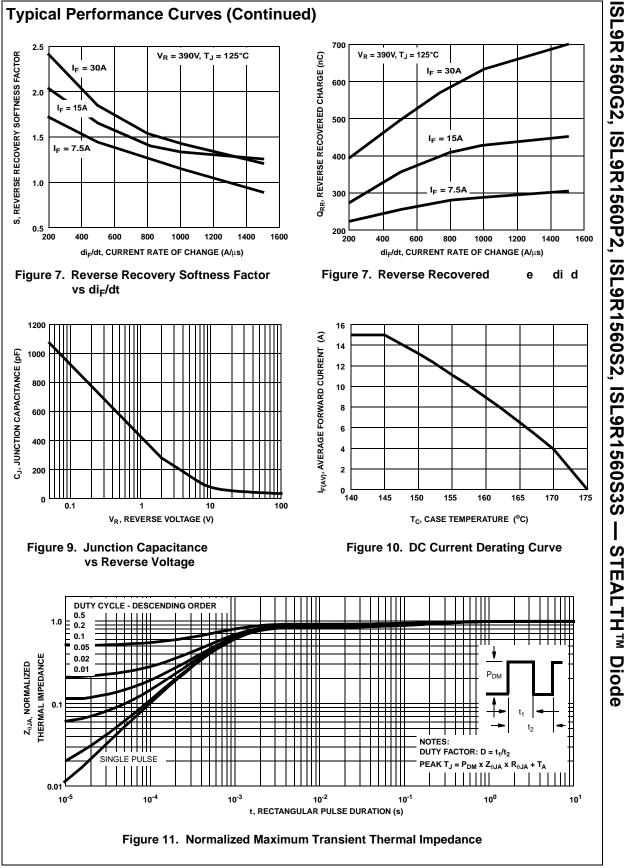
Device Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit V	
V _{RRM}	Repetitive Peak Reverse Voltage	600		
V _{RWM}	Working Peak Reverse Voltage	600	V	
V _R	DC Blocking Voltage	600	V	
I _{F(AV)}	Average Rectified Forward Current (T _C = 145°C)	15	A	
I _{FRM} Repetitive Peak Surge Current (20kHz Square Wave)		30	A	
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	200	A	

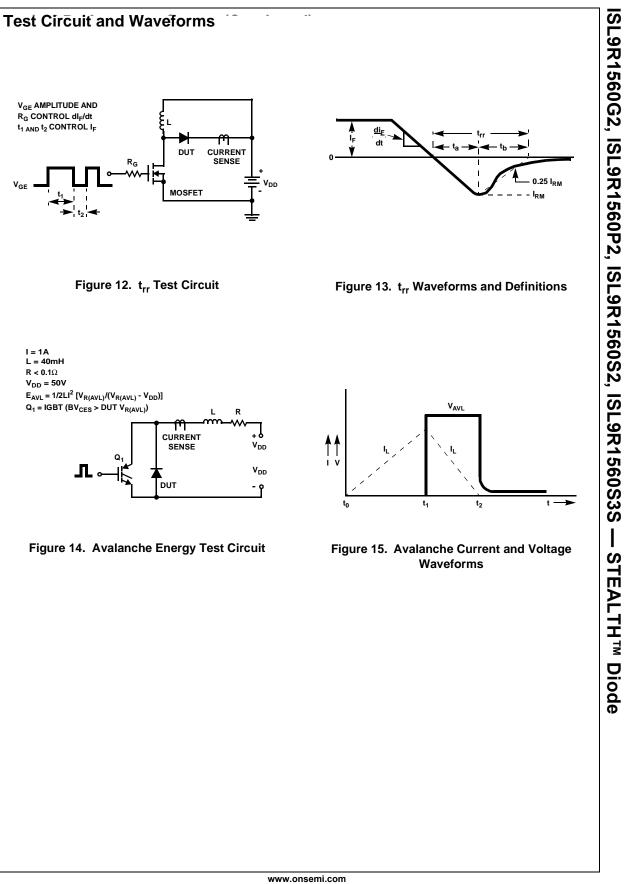
Symbol		Parameter					Ratings		Unit
P _D Power Dissipation					150			W	
E _{AVL} Avalanche Energy (1 A, 40 mH)					20			mJ	
T _J , T _{STG} Operating and Storage Temperature R			Range		-5	5 to 175		°C	
ΤL		•	rature for Soldering			300			°C
Т _{РКG}			n (1.6mm) from Cas or 10s, See Techbr			260		°C	
operatio	on of th	e device at these or a		tings" may cause permaner ve those indicated in the open offormation					
art Nun	nber	Top Mark	Package	Packing Method	Reel Size	Tape Width		Quantity	
SL9R1560G2		ISL9R1560G2	TO-247-2L	Tube	N/A	N/A		30	
SL9R1560P2		ISL9R1560P2	TO-220AC-2L	Tube	N/A	N/A		50	
SL9R1560S2		ISL9R1560S2	TO-262(I ² -PAK)	Tube	N/A	N/A		50	
L9R1560S3ST		ISL9R1560S3S	TO-263(D ² -PAK)	Reel	13" dia	24mm		800	
Electri	cal			unless otherwise not	èd	•			
Symbol		Param	-	Test Cond		Min	Тур	Max	Unit
,	- - Ch	aracteristics					.76		U
	-	nstantaneous Reverse Current	e Current	V _R = 600 V	T _C = 25°C		-	100	
	mst	anianeous Revers	se Current		$T_{\rm C} = 25 {\rm C}$ $T_{\rm C} = 125^{\circ}{\rm C}$	-	-	1.0	μA mA
On State	e Ch	aracteristics							
V _F Instanta		antaneous Forwa	rd Voltage	I _F = 15 A	T _C = 25°C	-	1.8	2.2	V
					T _C = 125°C	-	1.65	2.0	V
•	-	aracteristics		1		T	r		1
CJ	C _J Junction Capacitance		V _R = 10 V, I _F = 0 A		-	62	-	pF	
Switchir	ng C	haracteristics	5						
t _{rr}	Rev	verse Recovery Time		$I_F = 1 \text{ A}, \text{ di}_F/\text{dt} = 100 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	25	30	ns
				$I_F = 15 \text{ A}, \text{ di}_F/\text{dt} = 100$	A/ μ s, V _R = 30 V	-	35	40	ns
t _{rr}	Rev	everse Recovery Time		$I_{\rm F} = 15 {\rm A},$		-	29.4	-	ns
۱ _{rr}		everse Recovery Current		di _F /dt = 200 A/µs, V _R = 390 V, T _C = 25°C		-	3.5	-	Α
Q _{rr}		everse Recovered Charge		-	57	-	nC		
t _{rr}		erse Recovery Ti		$I_{\rm F} = 15 {\rm A},$		-	90	-	ns
S		both the sector (t_b/t_a) discrimination of the sector (t_b/t_a) discrimination of the sector $V_R = 390 \text{ V},$			-	2.0	-		
I _{rr}		Reverse Recovery Current		$T_{\rm C} = 125^{\circ}{\rm C}$		-	5.0	-	A
Q _{rr}	_	erse Recovered (0	1 - 15 ^		-	275	-	nC
t _{rr}		erse Recovery Til		$I_{F} = 15 \text{ A},$ $di_{F}/dt = 800 \text{ A}/\mu\text{s},$ $V_{R} = 390 \text{ V},$		-	52	-	ns
S		tness Factor (t _b /t _a)				-	1.36	-	^
I _{rr}	_	veverse Recovery Current $V_R = 330$ V, reverse Recovered Charge $T_C = 125^{\circ}C$				-	13.5 390	-	A nC
Q _{rr} di _M /dt	_	kimum di/dt during	0	-		-	800	-	A/µs
			b, p	1		I -	000	-	Γνμο
		aracteristics	hundring to C	1		1	<u>г</u>	4.0	00/141
R _{θJC}	_	rmal Resistance		TO 247		-	-	1.0	°C/W
R _{θJA}	_		Junction to Ambient			-	-	30	°C/W
	1 I DE	Thermal Resistance Junction to Ambient TO-220 Thermal Resistance Junction to Ambient TO-262			ı -	-	62	°C/W	
$R_{ heta JA}$ $R_{ heta JA}$	_						-	62	°C/W



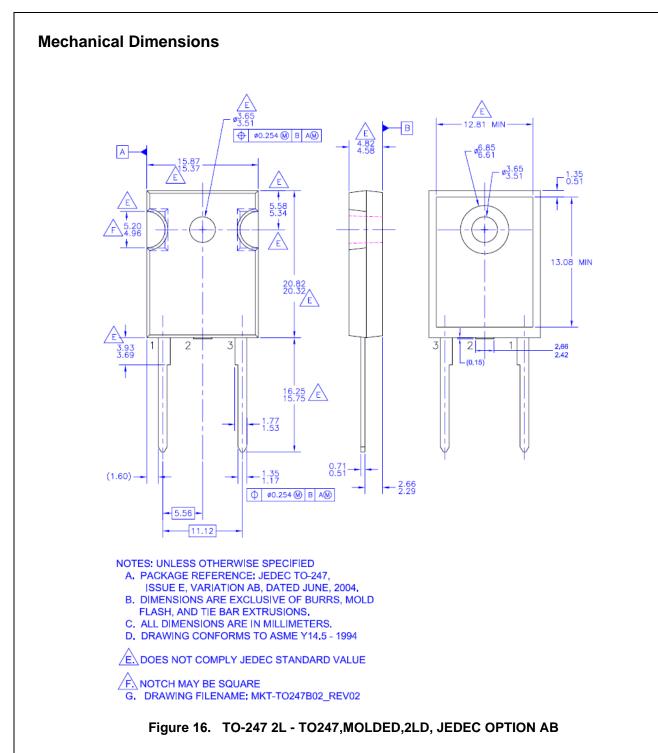
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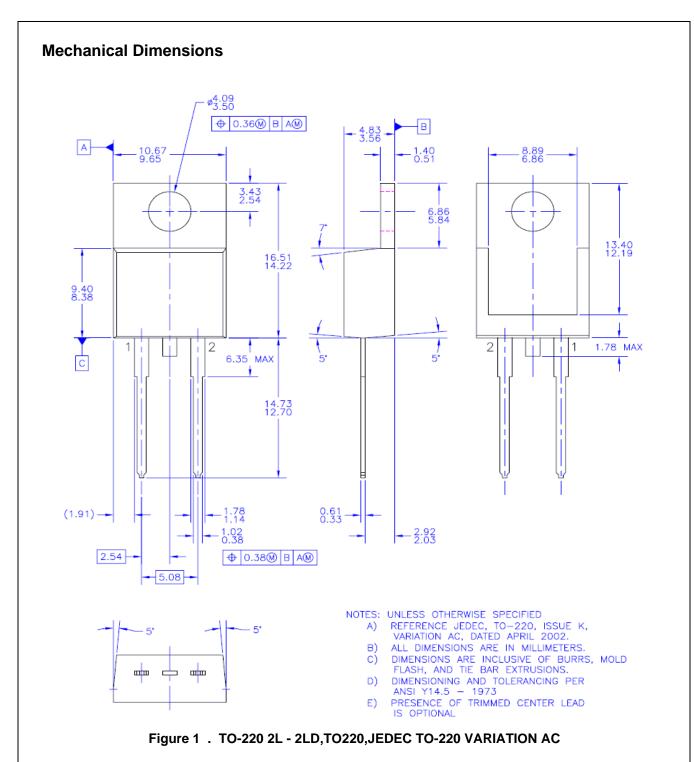


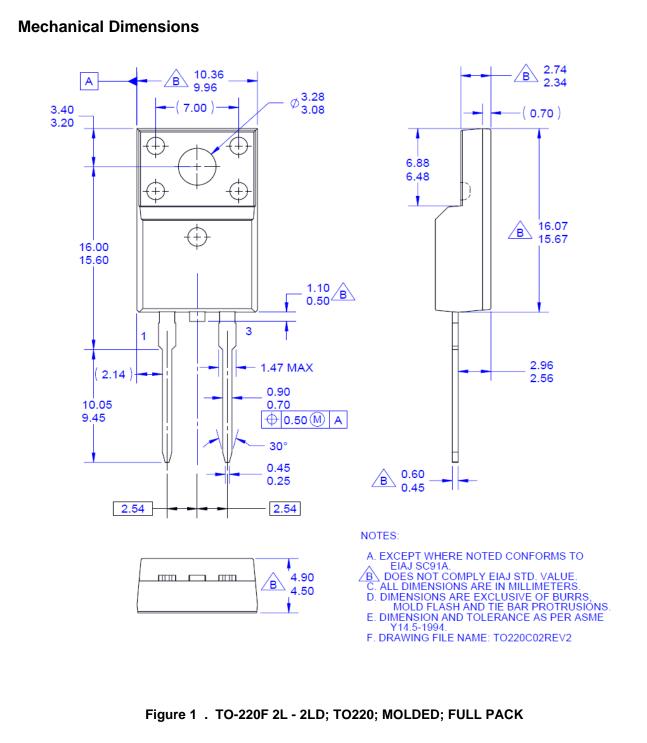
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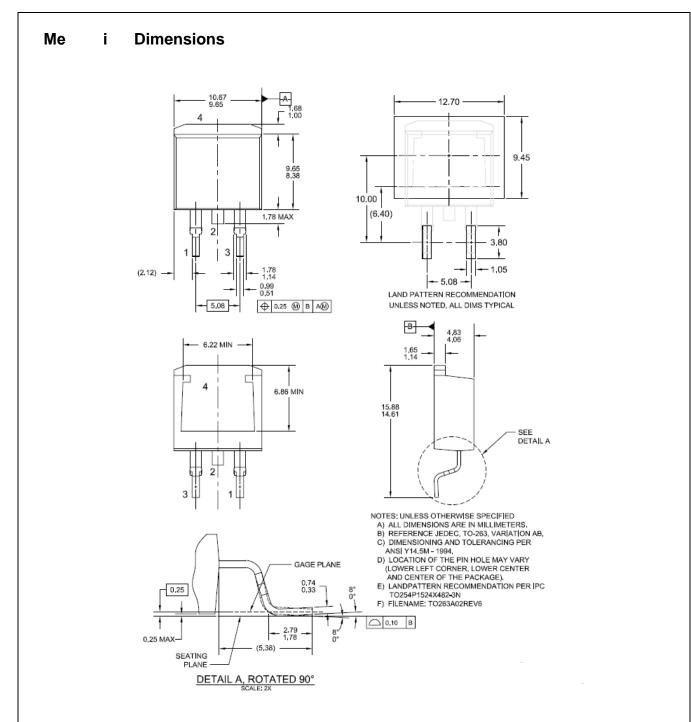


Figure 19. TO-263 2L (D2PAK) - 2LD, TO263, SURFACE MOUNT

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